L Number	Hits	Search Text	DB	Time stamp
- Number	2	("6664621").PN.	USPAT;	2004/06/16
	-		US-PGPUB;	12:43
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	66060	microelectronic	USPAT;	2004/06/16
			US-PGPUB;	12:43
			EPO; JPO;	
			DERWENT;	
	543	microelectronic and interconnect and	IBM_TDB USPAT;	2004/06/16
-	543	(active same microelectronic)	US-PGPUB;	12:44
		(active same microerectionic)	EPO; JPO;	12.44
			DERWENT;	
			IBM TDB	
_	352	(microelectronic and interconnect and	USPAT;	2004/06/16
•		(active same microelectronic)) and	US-PGPUB;	12:44
		(terminal or lead)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	23	((microelectronic and interconnect and	USPAT;	2004/06/16
		(active same microelectronic)) and	US-PGPUB;	12:49
		(terminal or lead)) and ((terminal or	EPO; JPO;	
		lead) same (movable or moveable))	DERWENT;	
	22	///mignoplogtnonia and interesting	IBM_TDB USPAT;	2004/06/16
-	22	(((microelectronic and interconnect and (active same microelectronic)) and	US-PGPUB;	12:50
		(terminal or lead)) and ((terminal or	EPO; JPO;	12.50
		lead) same (movable or moveable))) and	DERWENT;	
		(copper or cu or gold or au or ag or	IBM TDB	
		silver)		
-	8	(((microelectronic and interconnect and	USPAT;	2004/06/16
		(active same microelectronic)) and	US-PGPUB;	12:50
		(terminal or lead)) and ((terminal or	EPO; JPO;	
		lead) same (movable or moveable))) and	DERWENT;	
		(copper or cu or gold or au or ag or	IBM_TDB	
		silver)) and (interconnect same (copper		
1	63	or cu or gold or au or ag or silver)) ((microelectronic and interconnect and	USPAT;	2004/06/16
-	63	(active same microelectronic)) and	US-PGPUB;	12:49
ļ		(terminal or lead)) and ((terminal or	EPO; JPO;	12.13
		lead) same (movable or moveable or	DERWENT;	
		flexible or frangible))	IBM TDB	
-	60	(((microelectronic and interconnect and	USPAT;	2004/06/16
		(active same microelectronic)) and	US-PGPUB;	12:50
		(terminal or lead)) and ((terminal or	EPO; JPO;	
		lead) same (movable or moveable or	DERWENT;	
		flexible or frangible))) and (copper or	IBM_TDB	
_	27	cu or gold or au or ag or silver) ((((microelectronic and interconnect and	HSDAT.	2004/06/16
1	1 2/	((((microelectronic and interconnect and (active same microelectronic)) and	USPAT; US-PGPUB;	13:03
		(terminal or lead)) and ((terminal or	EPO; JPO;	13.03
		lead) same (movable or moveable or	DERWENT;	
		flexible or frangible))) and (copper or	IBM TDB	
		cu or gold or au or ag or silver)) and	_	
		(interconnect same (copper or cu or gold		
		or au or ag or silver))		
-	20	1 , , , , , , , , , , , , , , , , , , ,	USPAT;	2004/06/16
		(active same microelectronic)) and	US-PGPUB;	13:05
	1	(terminal or lead)) and ((terminal or	EPO; JPO;	
		lead) same (movable or moveable or flexible or frangible))) and (copper or	DERWENT; IBM TDB	
		cu or gold or au or ag or silver)) and	TPH_TDB "	
		(interconnect same (copper or cu or gold		
		or au or ag or silver))) and (438/\$.ccls.		
		or 257/\$.ccls.)		

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14	(((((microelectronic and interconnect and (active same microelectronic)) and	USPAT; US-PGPUB;	2004/06/16 13:05
	<pre>(terminal or lead)) and ((terminal or lead) same (movable or moveable or</pre>	EPO; JPO; DERWENT;	
	flexible or frangible))) and (copper or cu or gold or au or ag or silver)) and	IBM_TDB	
	<pre>(interconnect same (copper or cu or gold or au or ag or silver))) and (438/\$.ccls.</pre>		
	or 257/\$.ccls.)) and pad and (bond\$3 near10 (pressure or force))		
14		USPAT; US-PGPUB;	2004/06/16
	(terminal or lead)) and ((terminal or	EPO; JPO; DERWENT;	
	flexible or frangible))) and (copper or	IBM_TDB	
	(interconnect same (copper or cu or gold		
	or 257/\$.ccls.)) and pad and (bond\$3		
		and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))) and (copper or cu or gold or au or ag or silver)) and (interconnect same (copper or cu or gold or au or ag or silver))) and (438/\$.ccls. or 257/\$.ccls.)) and pad and (bond\$3 near10 (pressure or force))  ((((((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))) and (copper or cu or gold or au or ag or silver)) and (interconnect same (copper or cu or gold or au or ag or silver))) and (438/\$.ccls.	and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))) and (copper or cu or gold or au or ag or silver)) and (interconnect same (copper or cu or gold or au or ag or silver)) and (438/\$.ccls. or 257/\$.ccls.)) and pad and (bond\$3 near10 (pressure or force)) ((((((microelectronic and interconnect and (active same microelectronic)) and (terminal or lead)) and ((terminal or lead) same (movable or moveable or flexible or frangible))) and (copper or cu or gold or au or ag or silver)) and (interconnect same (copper or cu or gold or au or ag or silver))) and (438/\$.ccls. or 257/\$.ccls.)) and pad and (bond\$3